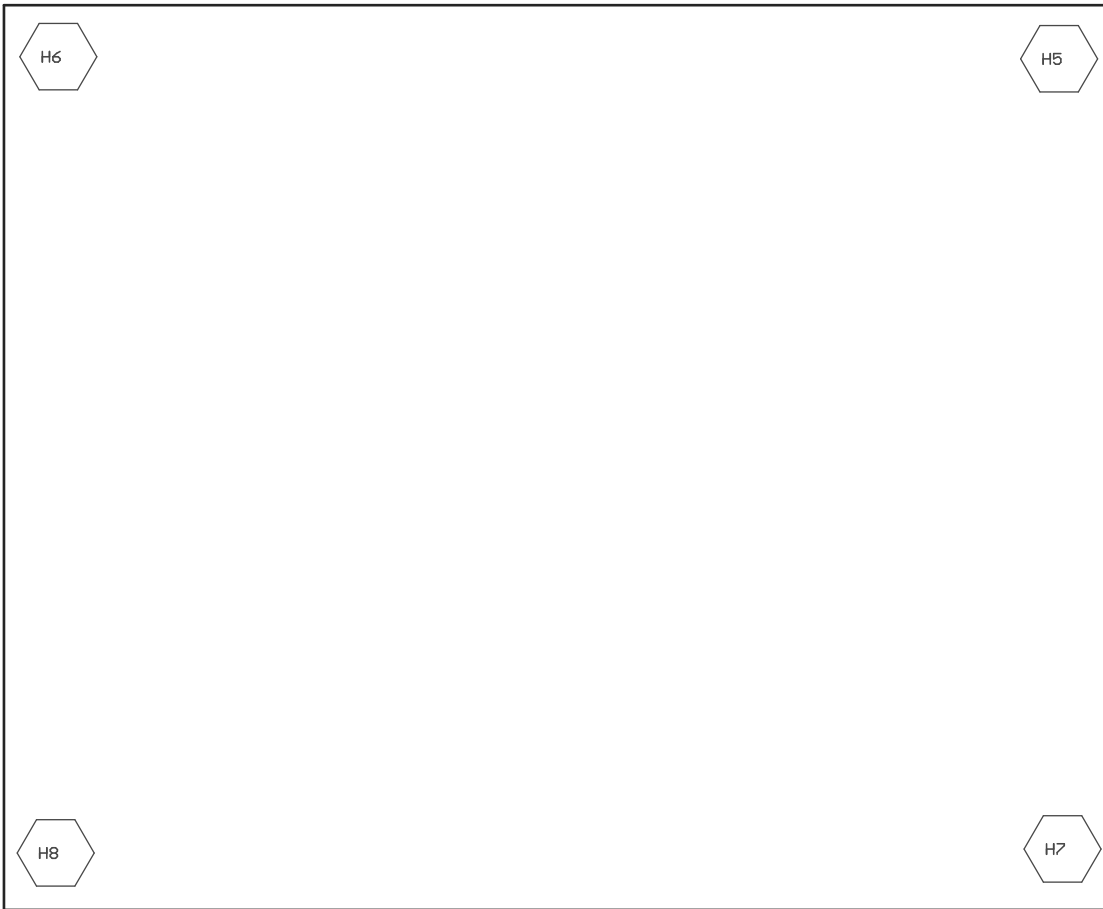


| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: TIDA00858 | REV: E1 | SUN REV: Not In VersionControl |
| | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 11/11/2015 6:04:14 PM | TEXAS INSTRUMENTS | |



PCB VIEWED FROM BOTTOM SIDE

| | | | |
|-------------------------------------|-----------------------------------|-------------------|--------------------------------|
| | BOARD #: TIDA00858 | REV: E1 | SUN REV: Not In VersionControl |
| | | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 11/11/2015 6:04:15 PM | TEXAS INSTRUMENTS | |

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